



DRTR5V0U2SR

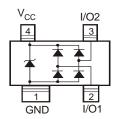
2 CHANNEL LOW CAPACITANCE TVS DIODE ARRAY

Features

- IEC 61000-4-2 (ESD): Air ±15kV, Contact ±8kV
- 2 Channels of ESD Protection
- Low Channel Input Capacitance of 1.0pF Typical
- Typically Used at High Speed Ports such as USB 2.0, IEEE1394, Serial ATA, DVI, HDMI, PCI
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT143
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.009 grams (approximate)



Device Schematic

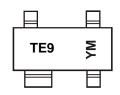
Ordering Information (Note 4)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DRTR5V0U2SR-7	AEC-Q101	TE9	7	8	3,000/Tape & Reel

Notes:

- $1.\ No\ purposely\ added\ lead.\ Fully\ EU\ Directive\ 2002/95/EC\ (RoHS)\ \&\ 2011/65/EU\ (RoHS\ 2)\ compliant.$
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



TE9 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Year	201:	3	2014		2015	20	16	2017		2018	2	2019
Code	Α		В		С)	Е		F		G
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	I _{PP}	5	Α	8/20µs, Per Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±8	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±15	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Power Dissipation (Note 5)	P_{D}	400	mW	
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	310	°C/W	
Operating and Storage Temperature Range	T_J , T_{STG}	-65 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}	_	_	5.5	V	_
Channel Leakage Current (Note 6, 7)	I _R	_	1	100	nA	$V_R = 3V$
Reverse breakdown voltage	V_{BR}	6.0	_	9.0	V	I _R = 1mA, from pin 4 to pin 1
Forward Voltage (Note 7)	V _F	_	0.8	_	V	I _F = 8mA
Dynamic Resistance (Note 7)	R _{DYN}	_	0.9	_	Ω	$I_{PP} = 1A, t_p = 8/20\mu s$
I/O to GND Capacitance (Note 7)	C _(I/O-GND)	_	1.0	1.5	pF	$V_{(I/O-GND)} = 0V, f = 1MHz$

Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Measured from pin 2 or pin 3 to GND.
- 8. For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/destools/appnote_dnote.html.

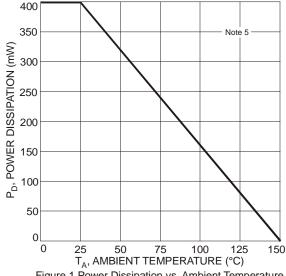
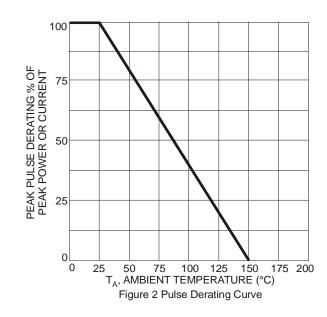
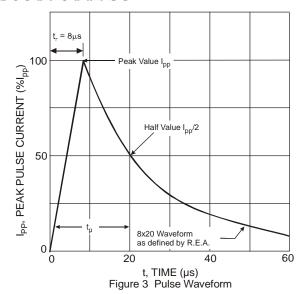
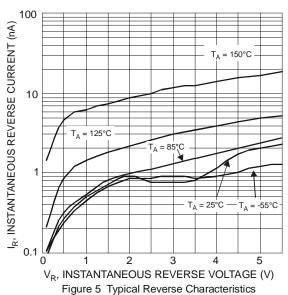


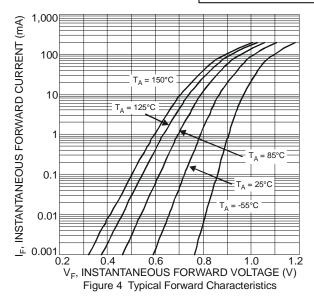
Figure 1 Power Dissipation vs. Ambient Temperature











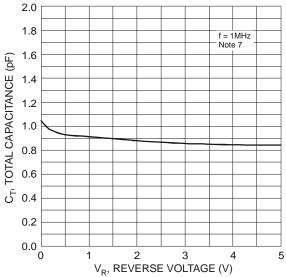
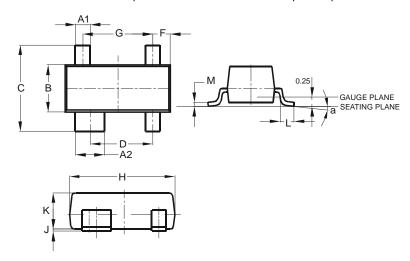


Figure 6 Typical Total Capacitance vs. Reverse Voltage

Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

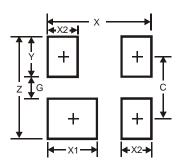


SOT143							
Dim	Min	Max	Тур				
A1	0.37	0.51	0.400				
A2	0.77	0.93	0.800				
В	1.20	1.40	1.30				
С	2.28	2.48	2.38				
D	1.58	1.83	1.72				
F	0.45	0.60	0.49				
G	1.78	2.03	1.92				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.89	1.00	-				
L	0.46	0.60	0.50				
М	0.085	0.18	0.11				
а	0°	8°	-				
All Dimensions in mm							



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
Z	2.70			
G	1.30			
Х	2.50			
X1	1.0			
X2	0.60			
Y	0.70			
С	2.0			

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